

AMENDMENT UNDER 37 C.F.R. § 1.116  
EXPEDITED PROCEDURE  
GROUP 2841  
**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q92997

Yasukazu NAKATA, et al.

Appln. No.: 10/567,358

Group Art Unit: 2841

Confirmation No.: 9855

Examiner: Dameon E. LEVI

Filed: February 6, 2006

For: FLIP CHIP MOUNTING SUBSTRATE

**AMENDMENT UNDER 37 C.F.R. § 1.116**

**MAIL STOP AF**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated May 23, 2007, please amend the above-identified application as follows on the accompanying pages.

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